

NOT RECOMMENDED FOR NEW DESIGN USE DMN2451UFDQ



DMN2400UFDQ

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	Rds(on)	I _D T _A = +25°C
	0.6Ω @ V _{GS} = 4.5V	0.9A
20V	0.8Ω @ V _{GS} = 2.5V	0.7A
	1.0Ω @ V _G S = 1.8V	0.5A
	1.6Ω @ V _{GS} = 1.5V	0.3A

Features and Benefits

- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V Max.
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2400UFDQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

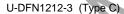
Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Power management functions
- Battery operated systems and solid-state relays
- Load switches

Mechanical Data

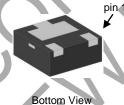
- Package: U-DFN1212-3
- Package Material: Molded Plastic;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @4
- Terminal Connections: See Diagram
- Weight: 0.005 grams (Approximate)

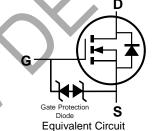


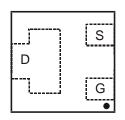




Top View







Pin-Out Top View

Ordering Information (Note 4)

Part Number	Package	Packing			
Part Number	Раскауе	Qty.	Carrier		
DMN2400UFDQ-7	U-DFN1212-3 (Type C)	3,000	Tape & Reel		
DMN2400UFDQ-13	U-DFN1212-3 (Type C)	10,000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



K24 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: J = 2022) M = Month (ex: 9 = September)

Date Code Key

Year	2015		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	С		J	K	L	М	N	0	Р	R	S	T
	1	1	1	1	1	1				1	1	
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	20	V		
Gate-Source Voltage			Vgss	±12	V
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	0.9 0.7	А
Continuous Drain Current (Note 6) V _{GS} = 2.5V	lo	0.7 0.5	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	IDM	3.0	Α		
Maximum Body Diode Forward Current (Note 6)	Is	0.8	Α		

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.44	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	283	°C/W
Total Power Dissipation (Note 6)		PD	0.85	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Rеja	147	°C/W
Thermal Resistance, Junction to Case (Note 6)		R _θ Jc	112	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

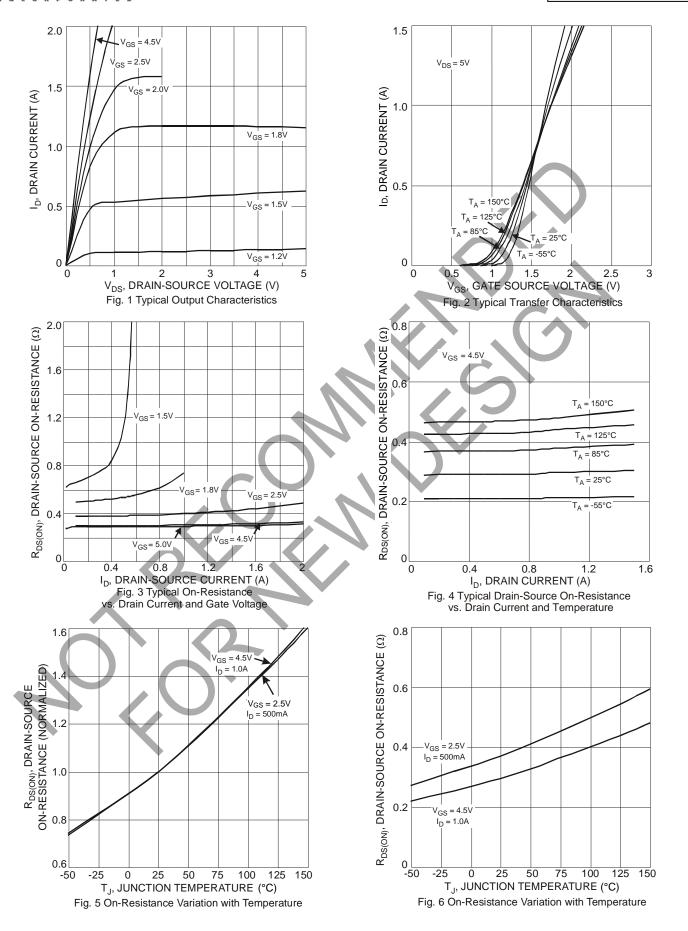
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	20	-		V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zoro Coto Voltogo Droin Current T. 125°C				80	nA	$V_{DS} = 4.5V, V_{GS} = 0V$
Zero Gate Voltage Drain Current T _J = +25°C	loss	_		100	IIA	$V_{DS} = 20V$, $V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±1.0	μΑ	$V_{GS} = \pm 4.5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(TH)	0.45	-	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
		-	0.35	0.6		$V_{GS} = 4.5V, I_{D} = 200mA$
Static Drain-Source On-Resistance	Dra/ou	ľ	0.45	0.8	Ω	$V_{GS} = 2.5V, I_{D} = 200mA$
Static Dialif-Source Off-Resistance	RDS(ON)	-	0.6	1.0	12	$V_{GS} = 1.8V, I_D = 100mA$
		-	0.7	1.6		$V_{GS} = 1.5V, I_{D} = 50mA$
Forward Transfer Admittance	Y _{fs}	-	1.4	-	S	$V_{DS} = 3V, I_{D} = 200mA$
Diode Forward Voltage	V _{SD}	-	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 500mA$
DYNAMIC CHARACTERISTICS (Note 8)	,					
Input Capacitance	Ciss	-	37.0	-	pF	101/11/01/01/
Output Capacitance	Coss	-	5.7	-	pF	V _{DS} =16V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	-	4.2	-	pF	1 = 1.0WHZ
Gate Resistance	Rg	-	68	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	Qg	-	0.5	-	nC	15/// 40//
Gate-Source Charge	Qgs	-	0.07	-	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250mA$
Gate-Drain Charge	Qgd	-	0.1	-	nC	1D = 250MA
Turn-On Delay Time	tD(ON)	-	4.06	-	ns	101/11/
Turn-On Rise Time	t _R	-	7.28	-	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	tD(OFF)	-	13.74	-	ns	$R_L = 47\Omega$, $R_G = 10\Omega$, $I_D = 200\text{mA}$
Turn-Off Fall Time	t _F	-	10.54	-	ns	TID = ZOUTIA

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1-inch square copper plate.
 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.







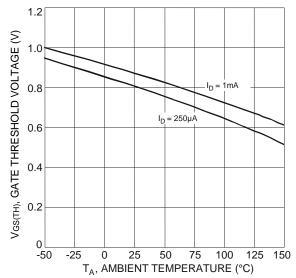
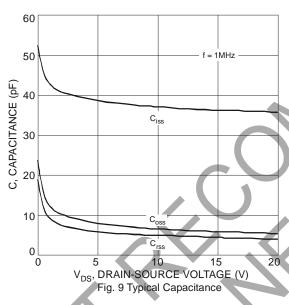
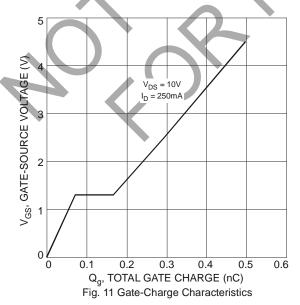
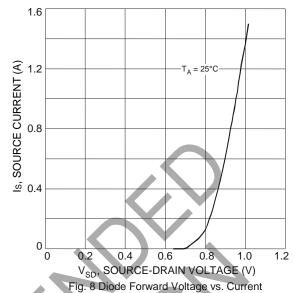
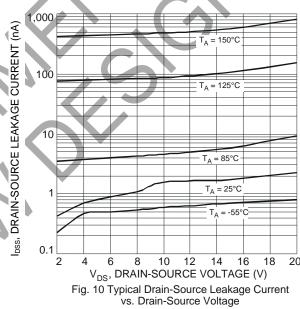


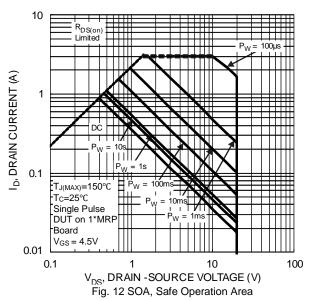
Fig. 7 Gate Threshold Variation vs. Ambient Temperature



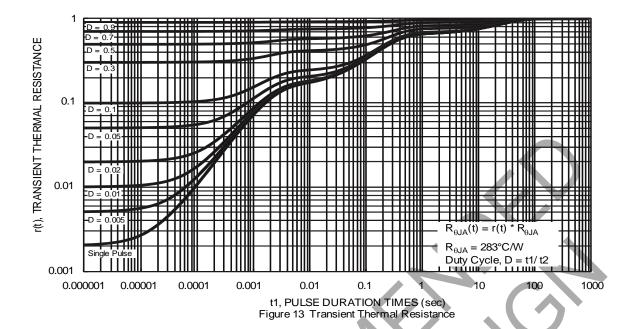










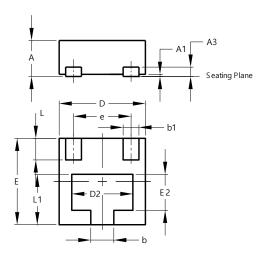




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN1212-3 (Type C)

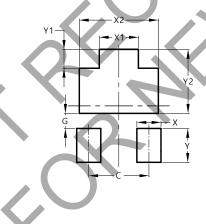


U-DFN1212-3								
	Type C							
Dim	Min	Max	Тур					
Α	0.47	0.53	0.50					
A1	0	0.05	0.02					
A3	•	1	0.13					
b	0.27	0.37	0.32					
b1	0.17	0.27	0.22					
D	1.15	1.25	1.20					
D2	0.75	0.95	0.85					
e	1	1	0.80					
E	1.15	1.25	1.20					
E2	0.40	0.60	0.50					
L	0.25	0.35	0.30					
L1	0.65	0.75	0.70					
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN1212-3 (Type C)



Dimensions	Value
Dillielisions	(in mm)
C	0.800
G	0.200
X	0.320
X1	0.520
X2	1.050
Υ	0.450
Y1	0.250
Y2	0.850



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